



# **Power Resistor for Mounting onto a Heatsink** Thick Film Technology



## **FEATURES**

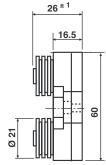
• High power rating: 250 W

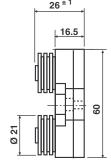
- High overload capability up to 4 times Nominal Power (see energy curve)
- · Easy mounting
- · Low thermal radiation of the case

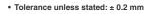
Developed for specific applications such as railroad electrical traction, this series can bear short overloads as high as fifteen times the nominal power. Designed to be mounted onto a heatsink, these power resistors exhibit remarkable characteristics.

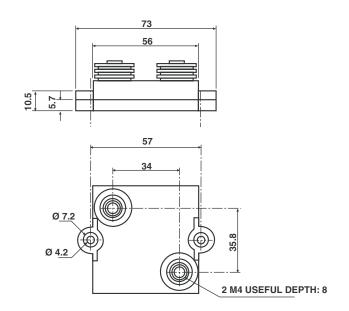
#### **DIMENSIONS** in millimeters

**RPS 250D** 









## **MECHANICAL SPECIFICATIONS**

**Mechanical Protection** Insulated case Substrate Alumina onto aluminum base

**Resistive Element** Cermet

**End Connections** Screws M4, (M5 on

request)

Tightening Torque on connections 2 Nm

Weight 170 g ± 10 %

## **ENVIRONMENTAL SPECIFICATIONS**

**Thermal Resistance** Rтн (j-c) 0.22 °C/W **Temperature Range** - 55 °C + 125 °C **Climatic Category** 55/125/56

ELECTRICAL SPECIFICATIONS				
Resistance Range	0.24 $\Omega$ to 1M E24 series			
Tolerances	± 1 % to ± 10 %			
Power Rating chassis mounted 250 W 1000 W	at 50 °C continuous at 25 °C for 10 seconds			
Temperature Coefficient Standard	± 250 ppm/°C < 1 ± 150 ppm/°C > 1			
Limiting Element Voltage	5 kVRMS			
Dielectric Strength MIL STD 202 (301), 1 minute, 10 mA Max	L connections 7 kVRMS H connections 12 kVRMS			
Insulation Resistance	$> 10^6\mathrm{M}\Omega$			
Inductance	< 50 nH			
Capacitance Resistor/ ground	< 40 pF < 120 pF			

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PERFORMANCE					
TESTS	CONDITIONS	TYPICAL DRIFTS			
Momentary Overload	NF EN 140 000 CEI 115_1 4 Pr/10 s	< ± (0.25 % + 0.05 Ω)			
Rapid Temperature Change	NF EN 140 000 CEI 68214 Test Na 5 cycles - 55 °C + 125 °C	< ± (0.25 % + 0.05 Ω)			
Load Life	NF EN 140 000 CEI 115_1 1000 h Pr at 70 °C	< ± (0.5 % + 0.05 Ω)			
Humidity (steady state)	MIL STD 202 Method 103 B and D 56 days R.H. 95 %	< ± (0.5 % + 0.05 Ω)			

RESISTANCE VALUE IN RELATION TO TOLERANCE AND TCR				
Ohmic Value	< 1 Ω	> 1 Ω		
Standard Tolerance	± 5 %	± 5 %		
Standard TCR	± 250 ppm/°C	± 150 ppm/°C		
Tolerance On Request	± 1 % - ± 2 % - ± 10 %			

#### CHOICE OF THE HEATSINK

The user must choose the heatsink according to the working conditions of the component (power, room temperature). Maximum working temperature must not exceed 125 °C. The dissipated power is simply calculated by the following ratio:

$$P \,=\, \frac{\Delta T}{\left[R_{TH}\,\left(j-c\right) + R_{TH}\,\left(c-a\right)\right]} \label{eq:problem}$$

P: expressed in W

T: difference between maximum working temperature and room temperature.

Rth: (j-c): thermal resistance value measured between resistive layer and outer side of the resistor. It is the thermal resistance of the component: (see specifications environmental paragraph).

Rth: (c-a): thermal resistance value measured between outer side of the resistor and room temperature. It is the thermal resistance of the heatsink itself (type, shape) and the quality of the fastening device.

### Example:

R<sub>TH</sub>: (c-a) for RPS 250 power dissipation 180 W at + 50 °C room temperature.

$$\begin{split} \Delta T &\leq 125~^{\circ}C - 50~^{\circ}C \leq 75~^{\circ}C \\ R_{TH} \left( j\text{-c} \right) + R_{TH} \left( c\text{-a} \right) = \frac{\Delta T}{P} = \frac{75}{180} = 0.42~^{\circ}\text{C/W} \\ R_{TH} \left( j\text{-c} \right) &= 0.22~^{\circ}\text{C/W} \\ R_{TH} \left( c\text{-a} \right) &\leq 0.42~^{\circ}\text{C/W} - 0.22~^{\circ}\text{C/W} \leq 0.20~^{\circ}\text{C/W} \end{split}$$

## RECOMMENDATIONS FOR MOUNTING ONTO A HEATSINK

Surfaces in contact must be carefully cleaned. The heatsink must have an acceptable flatness: from 0.05 mm to 0.1 mm/100 mm. Roughness of the heatsink must be around 6.3  $\mu$ m. In order to improve thermal conductivity, surfaces in contact should be coated with a silicone grease (type SI 340 from Rhône-Poulenc or Dow 340 from Dow Corning).

The fastening of the resistor to the heatsink is under pressure control of two screws (tightening torque 3 Nm).

In order to improve the dissipation, either forced-air cooling or liquid cooling may be used.

Do not forget to respect an insulation value between two resistors (dielectric strength in dry air 1 kV/mm).

In any case the hot spot temperature, measured locally on the case must not exceed 125 °C.

Test should be performed by the user.

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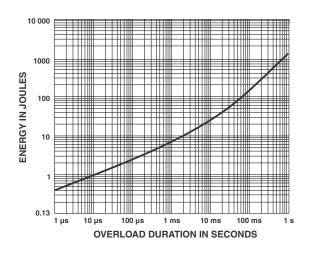
#### **OVERLOADS**

In any case the applied voltage must be lower than 2.5 Un. U maxi < 2.5 Un < 12500 V.

Short time overload: 4 Pn/10 seconds

Accidental overload: The values indicated on the graph below are applicable to resistors in air or mounted onto a heatsink.

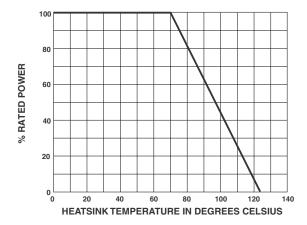
## **ENERGY CURVE**



#### **POWER RATING CHART**

The temperature of the heatsink should be maintained in the limit specified.

To improve the thermal conductivity, surfaces in contact should be coated with a silicone grease.



Packaging Box of 15 units

#### **MARKING**

Series, style, ohmic value (in  $\Omega$ ), tolerance in %, manufacturing date, VISHAY trademark

ORDERING INFORMATION							
RPS	250	DL	250U	1 %	ZA3	B015	е
MODEL	STYLE	CONNECTIONS Optional H: dielectric strength 12 kV L: dielectric strength 7 kV	RESISTANCE VALUE	TOLERANCE Optional ± 1 % ± 2 % ± 5 % ± 10 %	CUSTOM DESIGN Options on request special TCR, shape, etc.	PACKAGING	LEAD (Pb)-FREE

SAP PART NUMBERING GUIDELINES						
RPS	0250	DL	2500	F	В	ZA3
MODEL	STYLE	CONNECTIONS	OHMIC VALUE	TOLERANCE	PACKAGING	DESIGN

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